



A semi-empirical model for free-convection condensation on horizontal pin-fin tubes

Ali, HM; Briggs, A

Copyright © 2014 Elsevier Ltd. All rights reserved.

© 2014. This manuscript version is made available under the CC-BY-NC-ND 4.0 license

<http://creativecommons.org/licenses/by-nc-nd/4.0/> The final published version can be found here: <http://dx.doi.org/10.1016/j.ijheatmasstransfer.2014.10.008>

For additional information about this publication click this link.

<http://qmro.qmul.ac.uk/xmlui/handle/123456789/10884>

Information about this research object was correct at the time of download; we occasionally make corrections to records, please therefore check the published record when citing. For more information contact scholarlycommunications@qmul.ac.uk

1 **Abstract**

2 A simple semi-empirical correlation accounting for the combined effect of gravity and surface
3 tension has been developed for condensation on horizontal pin-fin tubes. The model divides the
4 heat transfer surface into five regions, i.e. two types of pin flank, two types of pin root and the
5 pin tip. Data for three fluids (i.e. steam, ethylene glycol and R113) condensing on eleven tubes
6 with different geometries were used in a minimization process to find three empirical constants
7 in the final expression. The model gives good overall agreement (within $\pm 20\%$) with the
8 experimental data, as well as correctly predicting the dependence of heat-transfer enhancement
9 on the various geometric parameters and fluid types.

10

11 **Key Words**

12 Condensation; pin-fin tube; semi-empirical correlation; heat transfer enhancement; phase change.

13

14

A Semi-Empirical Model for Free-Convection Condensation on Horizontal Pin-Fin Tubes

Hafiz Muhammad Ali ^a and Adrian Briggs ^b

^a Department of Mechanical Engineering, University of Engineering and Technology, Taxila 47050, Pakistan

^b School of Engineering and Materials Science, Queen Mary University of London, Mile End Road, London E1 4NS, UK

1. Introduction

A significant number of experimental investigations have been reported on free-convection condensation heat-transfer on horizontal integral-fin tubes; see for example [1-11]. During the condensation process, liquid retained on the lower part of tube insulates the fin flanks and root from heat transfer, This condensate retention on integral-fin tubes was first observed by Katz et al. [12] and afterwards experimentally investigated by many other investigators for a wide range of fluid and tube combinations [1, 3, 13, 14,15]. The development of an analytical correlation to predict this condensate retention angle (measured from the top of the tube up to the point where whole fin flanks become flooded with condensate) was a pivotal step for the development of a theoretical heat-transfer model for condensation on integral-fin tubes. Such an analytical correlation to predict condensate retention angle on integral-fin tube was first reported by Honda et al. [1] (later developed by Owen et al. [16] and Rudy and Webb [13]) to accomplish the requirement, the following expression was produced for retention angle, ϕ_f , measured from the top of the tube,

$$\phi_f = \cos^{-1} \left[\left(\frac{2\sigma \cos \theta}{\rho g s R_o} \right) - 1 \right] \text{ for } s < 2h \quad (1)$$

Reliable and simple heat-transfer models for integral-fin tubes (i.e. Honda and Nozu [17], Rose [18] and Briggs and Rose [19]) accounting for the combined effects of surface tension and gravity on heat-transfer were later developed which are now readily available for design engineers. With the help of above experimental and theoretical work, optimal tube geometries are now identified for a wide range of working fluids condensing on integral-fin tubes.

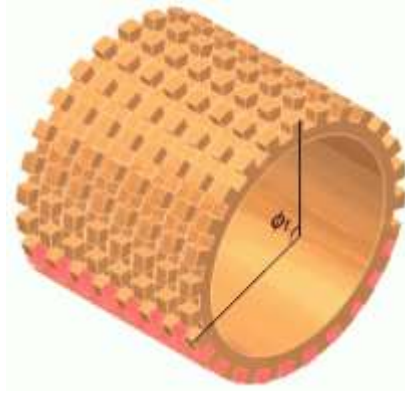
36 In the recent past, attention has been focused on more complex pin-fin tubes (a schematic of
37 three dimensional pin-fin tube with condensate retention angle is shown in Figure 1). Many
38 experimental investigations on pin-fin tubes (Sukathme et al. [20], Briggs [21], Baiser and
39 Briggs [22], Ali and Briggs [23, 24 and 25]) have shown their superior heat transfer performance
40 (up to 25%) over the equivalent integral-fin tubes (i.e. with the same fin height, root diameter
41 and longitudinal pin thickness and spacing). When Briggs [22] tested steam, four out of six pin-
42 fin tubes were fully flooded with condensate i.e. the only available area for heat transfer was the
43 pin tips. When compared with equivalent integral-fin tubes these fully flooded tubes gave about
44 20% more heat transfer, despite the fact that available area was only about half of the equivalent
45 integral-fin tube. Qin et al. [26] tested R134a condensing on two pin-fin tubes of different
46 geometries, one made of copper and another made of stainless steel. Heat transfer enhancements
47 were found to be 7.9 and 3.3 for copper and stainless steel pin-fin tubes respectively. The
48 superior performance of copper was due to its longer pin height and high thermal conductivity.

49 In order to exploit the superior experimental performance of pin-fin tubes, it is necessary to
50 develop a heat-transfer model to optimize these tubes to discover their full potential. For the
51 development of an accurate heat-transfer model for pin-fin tubes, the development of a predictive
52 correlation of condensate retention angles on pin-fin tubes was the start point which was recently
53 proposed by Ali and Briggs [27] as following equation;

$$\theta_f = \cos^{-1} \left[\left(1 - C \times \frac{s_c}{t_c} \right) \left(\frac{2\sigma}{\rho g s R_o} \right) - 1 \right] \quad \text{for } s < 2h \quad (2)$$

54 Equation 2 was found to give agreement within 15% with experimental retention angle data on
55 pin-fin tubes reported by the authors and also by other investigators [13, 14, and 20] for a wide
56 range of fluid and tube combinations.

57



58

59

Figure 1 Schematic of Three-Dimensional Pin-Fin Tube

60 Kumar et al. [28] proposed a generalized empirical model to predict the vapour-side, heat-
61 transfer coefficient on integral-fin and pin-fin tubes (the only theoretical model so far proposed
62 for condensation on pin-fin tubes). They proposed that the heat-transfer coefficient was a
63 function of fluid properties, tube geometry and condensate mass flow rate. They claimed
64 agreement to within $\pm 15\%$ with their own experimental data for one tube for steam and one for R-
65 134a, respectively. Cavallini et al. [29] and Namasivayam [30] reported the poor performance of
66 this model for copper integral-fin tubes. Later, Ali and Briggs [23] when compared this model
67 with experimental data of pin-fin tubes, it showed poor agreement with most of the data. One
68 possible reason for the inadequate performance of the model might be neglect of condensate
69 retention on the lower part of the tubes. In addition, the model is based on the assumption of a
70 linear pressure gradient along the pin or fin flank which has been shown to give poor results for
71 integral-fin tubes (see Briggs and Rose [31]).

72

73 More recently, Kundu and Lee [32] reported optimized profiles for vertical fins of variable cross
74 section subjected to condensation of saturated vapour under free convection, while Kundu [33]
75 and Kundu and Ghosh [34] extended the analysis to horizontal circular pins under free and
76 forced convection condensation respectively. These included the conjugate effects of conduction
77 in the pins. The choice of fin profiles, however, meant that surface tension effects could be
78 neglected and the condensation process was modeled assuming gravity drainage alone (in 32 and
79 33) and gravity plus vapour shear (in 34).

80

81 Finally, Nagarani et al. [35] presented a detailed review covering a wide range of extended
82 surfaces applications in heat transfer problems, including condensation on pin-fin tubes.

83

84 In the present work, a simple and reliable semi-empirical model to predict vapour-side, heat-
85 transfer enhancement ratio for condensation on horizontal pin-fin tubes has been developed. The
86 proposed model is based on an approach adopted in the models of Rose [18] and Briggs and
87 Rose [19] for condensation on horizontal integral-fin tubes. These authors modeled the effects of
88 gravity using the approach of Nusselt [36] and surface tension using dimensional analysis. The
89 model is validated in the light of earlier data for condensation on copper pin-fin tubes.

90 **2. Development of a Semi-Empirical Model for Condensation on Horizontal Pin-Fin** 91 **Tubes**

92

93 **2.1 Generalized Equations for Condensation Heat-Transfer Accounting for the Effects of** 94 **Gravity and Surface Tension**

95 The approach of Nusselt [36] for gravity drained condensation on flat plates and horizontal tube,
96 along with dimensional analysis for the effects of surface tension, suggests the following general
97 expressions for heat flux,

98 For an arbitrary flat surface at angle ϕ to the vertical,

99

$$100 \quad q_L = \left\{ \frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left(\frac{A_L \tilde{\rho} g \cos \phi}{x_L} + \frac{B \sigma}{x_L^3} \right) \right\}^{1/4} \quad (3)$$

101 where, x_L = linear dimension of plate length, $A_L = 0.943^4$ as suggested by Nusselt [36] theory for
102 a vertical plate and B is a constant for surface tension driven flow.

103 For a horizontal tube,

104

105

$$q_d = \left\{ \frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left(\frac{A_D \tilde{\rho} g}{x_D} + \frac{B \sigma}{x_\sigma^3} \right) \right\}^{1/4} \quad (4)$$

106

107

108

109

110

111

$$\xi(\phi_f) = 0.874 + 0.1991 \times 10^{-2} \phi_f - 0.2642 \times 10^{-1} \phi_f^2 + 0.5530 \times 10^{-2} \phi_f^3 - 0.1363 \times 10^{-2} \phi_f^4$$

(5)

112

113

where, ϕ_f is the flooding angle and for pin-fin tubes is calculated using equation 2.

114

115

116

117

118

119

It should be noted that x_σ appears in the denominators of equations 3 and 4 and so a decreasing x_σ will have a positive effect on heat flux. In addition, since surface tension effects will be most significant at the edges of the surfaces, where there are sharp changes in condensate surface curvature, surfaces with larger perimeters and smaller areas would be expected to have higher average heat fluxes. For these reasons, in equations 3 and 4, x_σ is here set equal to the ratio of area to perimeter for the appropriate condensing surface i.e. $x_\sigma = A/P$.

120

Expressions for Condensation Heat-Transfer Rate on Pin-Fin Tube

121

122

123

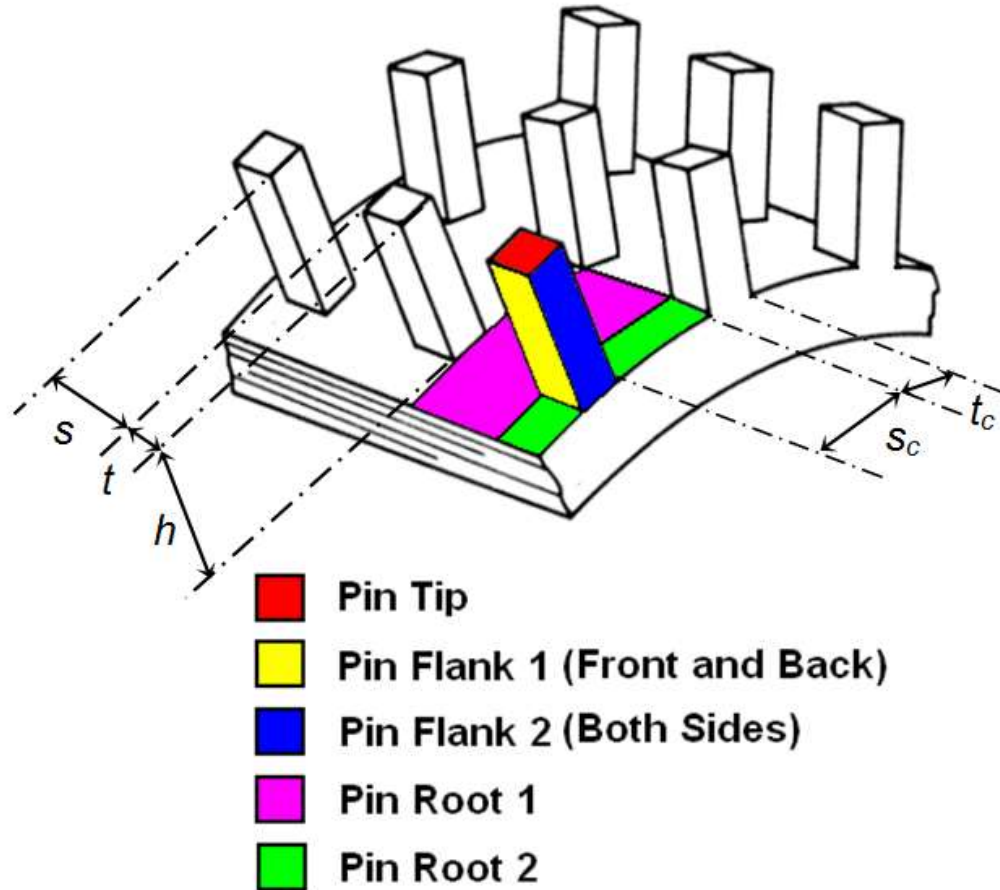
124

125

126

In this section, equations 3 and 4 are applied to the appropriate regions of the pin-fin tube to find separate expressions for the heat-transfer rate to these regions. Figure 2 identifies five regions on the pin-fin tubes for heat-transfer i.e. pin tip, pin flank 1, pin flank 2, pin root 1 and pin root 2. This division of pin-fin tube into five distinctive regions is necessary due to the very different geometrical configurations of the five regions; in particular their orientation with respect to gravity and to the expected differences in the effect of surface tension forces. For the pin tip

127 where there is no condensate flooding, all pin tips are considered active for heat transfer around
 128 the tube. For pin flanks and pin roots, there will be heat transfer only in the unflooded regions of
 129 the tube i.e. through pin flanks and pin roots not blanked by retained condensate.



130

131 Figure 2 Schematic of Pin-Fin Tube Identifying Five Regions for Heat-Transfer

132 **Pin Tip**

133 For a pin i making an angle ϕ to the vertical axis as shown in Figure 3, a pin tip with a
 134 longitudinal thickness of t and circumferential thickness of t_c can be treated as a flat plate.
 135 Applying equation 3 with $A_L = 0.943^4$, $x_L = t_c$ and $x_\sigma = A_{tip}/P_{tip}$, the heat flux can be written
 136 as,

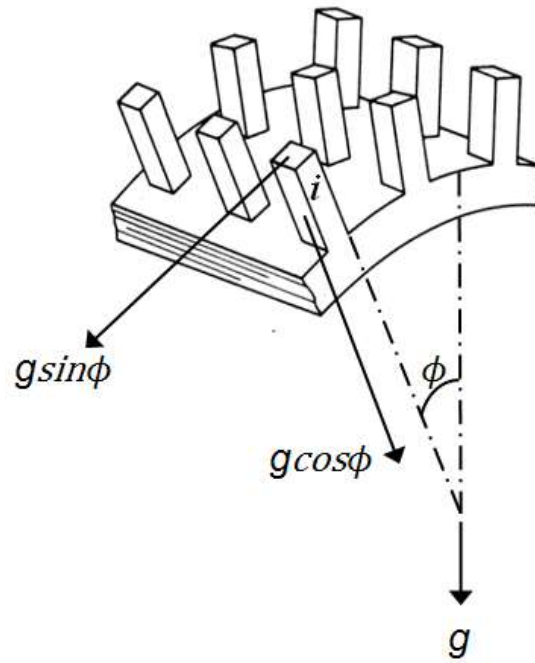
137

$$138 \quad q_{tip,i} = \left[\frac{\rho h_f g k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g \sin \phi}{t_c} + \frac{B_{tip} \sigma}{(A_{tip}/P_{tip})^3} \right\} \right]^{1/4} \quad (6)$$

139 where B_{tip} is an empirical constant and A_{tip}/P_{tip} is the area to perimeter ratio for the pin tip as
 140 follows,

141

$$142 \quad \frac{A_{tip}}{P_{tip}} = \frac{t_c t}{2(t_c + t)} \quad (7)$$



143

144 Figure 3 Physical Model of Pin-Fin Tube

145 When the total number of pins per circumference is n , ϕ for the i^{th} pin (counting from the top)
 146 can be given as,

147

$$148 \quad \phi = \frac{i}{n/2} \pi \quad (8)$$

149 Substituting equation 7 into equation 6 and multiplying by the pin-tip area gives the heat-transfer
 150 rate for pin tip i . Finally, the total heat-transfer rate for all the pin tips around the circumference
 151 can be obtained as,

$$152$$

$$153 \quad Q_{tip} = 2 \sum_{i=1}^{n/2} t_c t \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g \sin \phi}{t_c} + \frac{B_{tip} \sigma}{\left(\frac{t_c t}{2(t_c+t)} \right)^3} \right\} \right]^{1/4} \quad (9)$$

154 Pin Flank 1

155 For pin flank 1 (see Figure 2) with a longitudinal thickness t and height h , making an angle ϕ
 156 with the vertical plane as shown in Figure 3, equation 3 with $A_L = 0.943^4$, $x_L = h$ and $x_\sigma =$
 157 $A_{flank 1}/P_{flank 1}$, becomes,

$$158$$

$$159 \quad q_{flank 1,i} = \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g |\cos \phi|}{h} + \frac{B_{flank 1} \sigma}{\left(A_{flank 1}/P_{flank 1} \right)^3} \right\} \right]^{1/4} \quad (10)$$

160 Where $B_{flank 1}$ is an empirical constant and $A_{flank 1}/P_{flank 1}$ is the area to perimeter ratio for pin
 161 flank 1 given as,

$$162$$

$$163 \quad \frac{A_{flank 1}}{P_{flank 1}} = \frac{ht}{2(t+h)} \quad (11)$$

164 Substituting equation 11 into equation 10 and multiplying by area, the following expression
 165 gives the total heat-transfer rate for all pin flanks 1,

$$166$$

$$167 \quad Q_{flank 1} = 4 \sum_{i=1}^{j/2} ht \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g |\cos \phi|}{h} + \frac{B_{flank 1} \sigma}{\left(\frac{ht}{2(t+h)} \right)^3} \right\} \right]^{1/4} \quad (12)$$

168 Here j is the total number of pins above the flooding point, since those below this point will be
 169 insulated to heat transfer by the retained condensate. j can be calculated as follows,

170

$$171 \quad j = n \frac{\phi_f}{\pi} \quad (13)$$

172 **Pin Flank 2**

173 Applying equation 3 to pin flank 2 (see Figure 2) with $A_L = 0.943^4$, $x_L = h_v$ and $x_\sigma =$
 174 $A_{flank\ 2}/P_{flank\ 2}$ gives,

175

$$176 \quad q_{flank\ 2,i} = \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g}{h_v} + \frac{B_{flank\ 2} \sigma}{(A_{flank\ 2}/P_{flank\ 2})^3} \right\} \right]^{1/4} \quad (14)$$

177 where $B_{flank\ 2}$ is an empirical constant and $A_{flank\ 2}/P_{flank\ 2}$ is the area to perimeter ratio for pin
 178 flank 2, given as,

179

$$180 \quad \frac{A_{flank\ 2}}{P_{flank\ 2}} = \frac{ht_c}{2(t_c + h)} \quad (15)$$

181 h_v in equation 14 is a mean vertical pin height (see Figure 4) for a pin making angle ϕ with the
 182 vertical axis, and is given by,

183

$$184 \quad h_v = \frac{ht_c}{\left| \sqrt{h^2 + t_c^2} \sin(\phi + \beta) \right|} \quad (16)$$

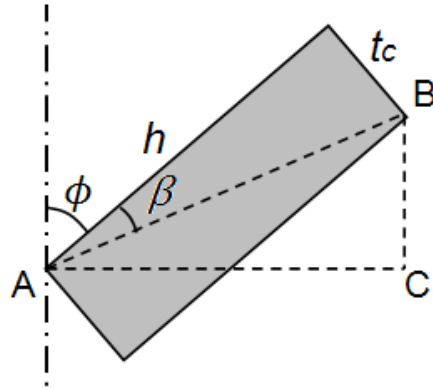
185 where,

$$186 \quad \beta = \tan^{-1}(t_c/h) \quad (17)$$

187 Substituting equations 15 and 16 into equation 14 and multiplying by the area, the total heat-
 188 transfer rate for all pin flanks 2 is given by,

189

$$190 \quad Q_{flank\ 2} = 4 \sum_{i=1}^{j/2} ht_c \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g}{\frac{ht_c}{\sqrt{h^2 + t_c^2} \sin(\phi + \beta)}} + \frac{B_{flank\ 2} \sigma}{\left(\frac{ht_c}{2(t_c + h)}\right)^3} \right\} \right]^{1/4} \quad (18)$$



$$h_v = \frac{Area}{AC} = \frac{ht_c}{|AB \sin(\phi + \beta)|} = \frac{ht_c}{\sqrt{h^2 + t_c^2} \sin(\phi + \beta)}$$

Where, $\beta = \tan^{-1}(t_c/h)$

191

192 Figure 4 Expressions for Mean Vertical Pin Height

193

194 Pin Root 1

195 Pin root 1 can be treated as a horizontal plain tube with the inclusion of condensate flooding on
 196 the lower part of tube as in Rose [18]. Applying equation 4 with $A_D = \{\xi(\phi_f)\}^3$, $x_D = d$ and
 197 $x_\sigma = A_{root\ 1}/P_{root\ 1}$, gives the following expression for heat flux,

198

199

$$q_{root\ 1} = \left\{ \frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left(\frac{\{\xi(\phi_f)\}^3 \tilde{\rho} g}{d} + \frac{B_{root\ 1} \sigma}{(A_{root\ 1}/P_{root\ 1})^3} \right) \right\}^{1/4} \quad (19)$$

201 where, $\xi(\phi_f)$ can be calculated using equation 5, $B_{root\ 1}$ is an empirical constant and
 202 $A_{root\ 1}/P_{root\ 1}$ is area to perimeter ratio for pin flank 1 and can be approximated as,

203

$$\frac{A_{root\ 1}}{P_{root\ 1}} = \frac{\phi_f ds}{2t_c j} \quad (20)$$

205 where, s is longitudinal pin spacing and j is calculated using equation 13. Substituting equation
 206 20 into equation 19 and multiplying by the area, the total heat-transfer rate can be given by,

207

$$Q_{root\ 1} = \phi_f ds \left\{ \frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left(\frac{\{\xi(\phi_f)\}^3 \tilde{\rho} g}{d} + \frac{B_{root\ 1} \sigma}{\left(\frac{\phi_f ds}{2t_c j}\right)^3} \right) \right\}^{1/4} \quad (21)$$

209 **Pin Root 2**

210 Since the circumferential pin spacing is usually quite small compared to the circumference of the
 211 tube, pin root 2 can be approximated to a flat plate. By applying equation 3 with $A_L = 0.943^4$,

212 $x_L = s_c$ and $x_\sigma = A_{root\ 2}/P_{root\ 2}$, the expression for the heat flux for a pin root 2 can be written

213 as,

214

$$q_{root\ 2,i} = \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g \sin \phi}{s_c} + \frac{B_{root\ 2} \sigma}{(A_{root\ 2}/P_{root\ 2})^3} \right\} \right]^{1/4} \quad (22)$$

215

216 where, $B_{root\ 2}$ is an empirical constant, s_c is the circumferential pin spacing, ϕ can be calculated
 217 using equation 15 and $A_{root\ 2}/P_{root\ 2}$ is the area to perimeter ratio for pin root 2 given by,
 218

$$219 \quad \frac{A_{root\ 2}}{P_{root\ 2}} = \frac{s_c t}{2t} = \frac{s_c}{2} \quad (23)$$

220 Substituting equation 23 into equation 22 and multiplying by the area of pin root 2 gives the
 221 following expression for the total heat-transfer rate to pin root 2,
 222

$$223 \quad Q_{root\ 2} = 2 \sum_{i=1}^{j/2} s_c t \left[\frac{\rho h_{fg} k^3 \Delta T^3}{\mu} \left\{ \frac{0.943^4 \tilde{\rho} g \sin \phi}{s_c} + \frac{B_{root\ 2} \sigma}{\left(\frac{s_c}{2}\right)^3} \right\} \right]^{1/4} \quad (24)$$

224 **2.2 Vapour-Side, Heat-Transfer Enhancement Ratio**

225 The total heat-transfer rate through a pin-fin tube for one longitudinal pin pitch can be computed
 226 as a sum of the heat-transfer rates to the pin tips, pin flanks and inter-pin roots. The vapour-side,
 227 heat-transfer enhancement ratio of the pin-fin tube at constant temperature difference, defined as
 228 the total heat-transfer rate to one longitudinal pin pitch of the pin-fin tube, divided by the heat-
 229 transfer rate to a plain tube of length equal to longitudinal pin pitch and diameter equal to the pin
 230 root diameter (which can be found from the Nusselt [36] theory of free-convection condensation
 231 on horizontal plain tubes) can be given by,
 232

$$233 \quad \varepsilon_{\Delta T} = \frac{Q_{tip} + Q_{flank\ 1} + Q_{flank\ 2} + Q_{root\ 1} + Q_{root\ 2}}{\pi d(t + s) \left\{ 0.728 \left(\frac{\rho \tilde{\rho} g h_{fg} k^3 \Delta T^3}{\mu d} \right) \right\}} \quad (25)$$

234
 235 Substituting equations 9, 12, 18, 21 and 24 into equation 25, the final expression for the vapour-
 236 side, heat-transfer enhancement ratio for a rectangular pin-fin tube can be written as,

$$\begin{aligned}
237 \quad \varepsilon_{\Delta T} &= \frac{2t_c t}{0.728\pi d(s+t)} \sum_{i=1}^{n/2} \left[\left\{ 0.943^4 \sin \phi \frac{d}{t_c} + B_{tip} \frac{d}{\left(\frac{t_c t}{2(t_c+t)}\right)^3 \tilde{\rho} g} \right\} \right]^{1/4} \\
238 \quad &+ \frac{4ht}{0.728\pi d(s+t)} \sum_{i=1}^{j/2} \left[\left\{ 0.943^4 |\cos \phi| \frac{d}{h} + B_{flank1} \frac{d}{\left(\frac{ht}{2(h+t)}\right)^3 \tilde{\rho} g} \right\} \right]^{1/4} \\
239 \quad &+ \frac{4ht_c}{0.728\pi d(s+t)} \sum_{i=1}^{j/2} \left[\left\{ 0.943^4 \frac{d}{\frac{ht_c}{\sqrt{h^2+t_c^2 \sin(\phi+\beta)}}} + B_{flank2} \frac{d}{\left(\frac{ht_c}{2(t_c+h)}\right)^3 \tilde{\rho} g} \right\} \right]^{1/4} \\
240 \quad &+ \frac{\phi_f s}{0.728\pi(s+t)} \left[\left\{ \{\xi(\phi_f)\}^3 + B_{root1} \frac{d}{\left(\frac{\phi_f ds}{2t_c j}\right)^3 \tilde{\rho} g} \right\} \right]^{1/4} \\
241 \quad & \\
242 \quad &+ \frac{2s_c t}{0.728\pi(s+t)} \sum_{i=1}^{j/2} \left[\left\{ 0.943^4 \sin \phi \frac{d}{s_c} + B_{root2} \frac{d}{\left(\frac{s_c}{2}\right)^3 \tilde{\rho} g} \right\} \right]^{1/4} \quad (26)
\end{aligned}$$

243 In equation 26, ϕ and β can be calculated using equations 8 and 17 and j can be found from
244 equation 13. Only two thermophysical properties are involved in the expression of enhancement
245 ratio i.e. surface tension, σ , and condensate density, ρ .

246 Determination of the Unknown Constants

247 Equation 26 contains 5 empirical constants B_{tip} , B_{flank1} , B_{flank2} , B_{root1} and B_{root2} which
248 need to be evaluated using experimental data. To make the case simple, the unknown constants
249 for pin flanks (i.e. pin flank 1 and pin flank 2) and for tube roots (i.e. root 1 and root 2) were
250 assumed to be the same i.e. $B_{flank1} = B_{flank2} = B_{flank}$ and $B_{root1} = B_{root2} = B_{root}$. These
251 three unknown constants, B_{tip} , B_{flank} and B_{root} were then found using a least square fit method
252 by minimizing the sum of squares of relative residuals in the vapour-side, heat-transfer
253 enhancement ratios.

254 For the minimization process, the experimental data used are taken from the investigations of
 255 (Briggs [21], Baiser and Briggs [22] and Ali and Briggs [23, 24 and 25]) on copper pin-fin tubes
 256 covering a range of data for 3 different condensing fluids (steam, ethylene glycol and R-113) and
 257 11 pin-fin tube geometries. As in the model, the vapour-side, enhancement ratios are defined as
 258 the heat flux of the pin-fin tube divided by that of a plain tube with diameter equal to the pin root
 259 diameter and at the same vapour-side temperature difference.

260 Table 1 gives the values of the three unknown constants, found by minimization of sum of
 261 squares of relative residuals of the vapour-side enhancement ratios, which gave the best fit of
 262 equation 26 to the data. A relative standard deviation was found to be 15.5 %.

263 Table 1 Empirical Constants

B_{tip}	B_{flank}	B_{root}	Std_{rel} *
0.02	0.001	0.01	15.49 %

264 * Relative standard deviation

265 The larger value of B_{tip} may be justified in the light of experimental data of steam reported by
 266 Briggs [21] who found significant enhancement ratios for fully flooded tubes, indicating that
 267 surface tension effects dominate on small pin tips where the sharp changes in surface curvature
 268 cause significant localized thinning the condensate layer.

269 The experimental values of vapour-side, heat-transfer enhancement ratios for all tube and fluid
 270 combinations used in the best fit process are listed in Table 2. Surface tension in equation 26 was
 271 calculated at saturation temperature of 470 K, 373 K and 320 K for ethylene glycol, steam and
 272 R-113 respectively, whereas condensate density was calculated at a reference temperature equal
 273 to the vapour temperature minus $2\Delta T/3$, where ΔT is the average vapour-side temperature
 274 difference of the experimental data, taken as 100 K, 20 K and 21 K for ethylene glycol, steam
 275 and R-113 respectively. Since the model neglects temperature drop along the pins the data used
 276 in the fitting process were restricted to those for copper tubes, where the effects of none uniform

277 pin surface temperature would be expected to be negligible (See Briggs and Rose [19] for
278 evidence that this is the case for integral-fin tubes.)

Table 2 Heat-Transfer Enhancement Ratios

Tubes	R-113 [22, 23, 24, 25]		Ethylene Glycol [23, 24, 25]		Steam [21, 22]	
	$(\epsilon_{\Delta T})_{calc}$	$(\epsilon_{\Delta T})_{obs}$	$(\epsilon_{\Delta T})_{calc}$	$(\epsilon_{\Delta T})_{obs}$	$(\epsilon_{\Delta T})_{calc}$	$(\epsilon_{\Delta T})_{obs}$
P1	3.59	3.34	3.58	2.86	3.19	2.59
P2	4.92	4.77	4.62	4.19	4.28	2.91
P3	5.34	5.83	4.31	4.08	2.22	2.34
P4	8.11	8.32	6.3	5.41	2.47	2.80
P5	5.81	6.51	5.03	4.06	2.11	2.47
P6	8.43	9.16	6.92	5.77	2.37	2.61
P7	5.46	5.92	5.29	4.91	4.74	3.86
P8	4.48	4.47	4.24	3.89	4.04	3.59
P10	4.81	5.77	4.45	4.89	4.05	4.41
P11	3.94	4.05	4.02	4.17	3.56	4.50
P12	3.36	3.99	3.3	3.50	3.1	3.98

280

281 3. Comparison of Semi-Empirical Expression with Experimental Data

282 Figure 5 gives a global comparison of the model with the available experimental data on copper
283 pin-fin tubes. It can be seen that equation 26 predicts nearly all the data to within $\pm 20\%$.

284 Figures 6a and 6b compares theory and experimental data plotted as dependence of enhancement
285 ratio on circumferential pin spacing, for $t_c = 0.5$ mm and $t_c = 1.0$ mm respectively. For both
286 fluids i.e. R-113 and ethylene glycol, equation 26 shows good agreement with experimental data
287 and predicts an increase in enhancement ratio with decreasing circumferential spacing suggesting

288 that a smaller circumferential pin spacing i.e. less than the smallest tested (0.5 mm) may produce
289 even higher heat-transfer enhancements for both fluids and circumferential pin thicknesses.
290 Figures 7a and 7b shows a similar pair of plots to Figures 6a and 6b, theory over predicts
291 enhancement ratios at $t_c = 0.5$ mm (Figure 7a) and under predicts at $t_c = 1.0$ mm (Figure 7b). This
292 could be due to the fact that the model does not account for temperature drop along the pins,
293 which for condensation of steam, where vapour-side, heat-transfer coefficients are high, could be
294 significant and lead to a decrease in decrease in “pin efficiency” at the lower pin thickness.

295 Figures 8 and 9 show the variation of enhancement ratio with pin height. The experimental data
296 show a reasonable agreement with the theory in all cases and predict the same dependence on
297 height and fluid. Better agreement with theory is seen for R-113. For steam and the highest pin
298 height (Figure 8a) theory over predicts data by about 40 %, possibly for the same reason as
299 explained above.

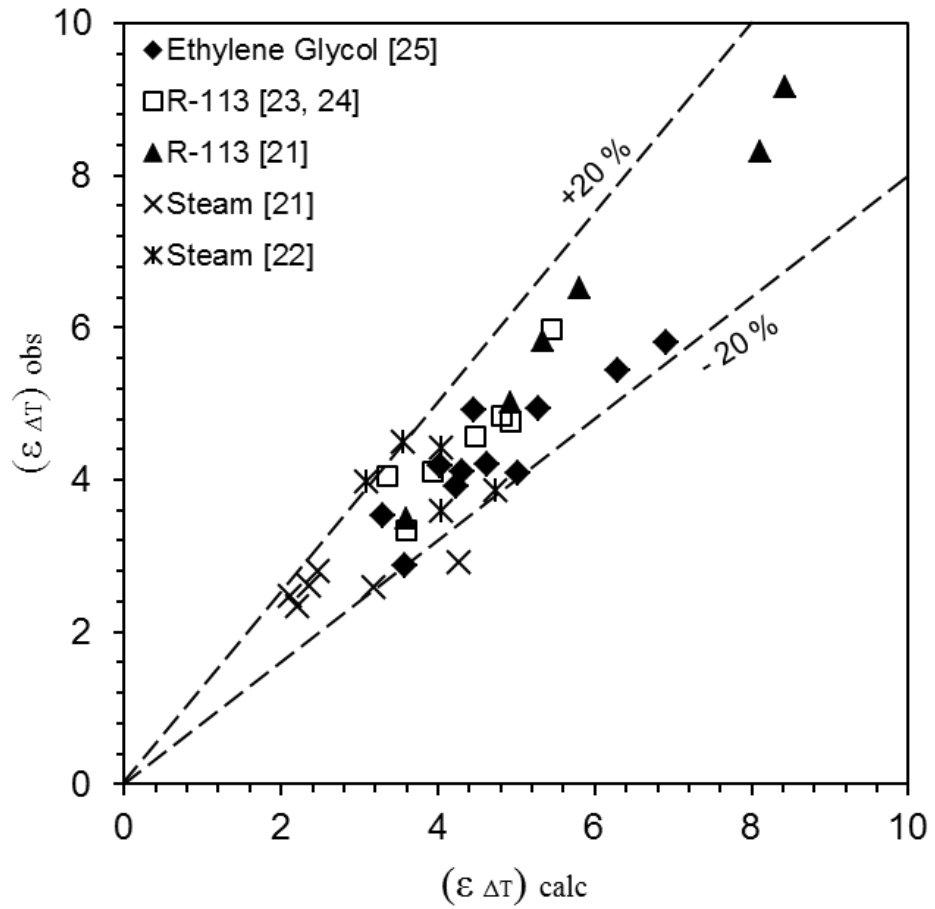
300 Figures 10a and 10b give dependence of enhancement ratio on circumferential pin thickness for
301 ethylene glycol and pin heights of 0.9 mm and 1.6 mm respectively while Figures 9c and 9d plot
302 enhancement ratio against circumferential pin thickness for circumferential pin spacings of 0.5
303 mm and 1.0 mm. For all cases, the theory predicts the data reasonably well, however, better
304 agreements is found at larger circumferential pin thickness.

305 Figures 11a and 11b compare the theory with experimental data of R-113 and steam with
306 enhancement ratio plotted as a function of circumferential pin thickness at pin heights of 0.9 mm
307 and 1.6 mm. Values and overall trends are again in very good agreement.

308 **4. Conclusion**

309 A semi-empirical correlation based on the approach used in the models of Rose [18] and Briggs
310 and Rose [19] to account for the combined effect of gravity and surface tension has been
311 developed for condensation on horizontal pin-fin tubes (i.e. equation 26). Important results are
312 given below;

- 313
- 314
- 315
- 316
- 317
- 318
- 319
- 320
- 321
- 322
- 323
- 324
- 325
- 326
- 327
- 328
- 329
- The model predicts experimental data, covering enhancement ratios in a range from 2.5 to 9.2, for three fluids (i.e. steam, ethylene glycol and R113) and eleven tubes of different geometries, to within $\pm 20\%$ (see Figure 5).
 - Detailed comparison between the model and experimental data indicate that the model satisfactorily predicts the dependence of heat transfer enhancement on both geometric variables and fluids. This suggests the model could be used to optimize tube geometries for given applications. Such an optimization exercise would be complex, given that the model includes six independent geometric variables. Recent work [e.g. 37-39] however suggests possible approaches for such optimization procedures.
 - The comparisons with data for condensation of steam suggest that where heat-transfer coefficients are high, “fin efficiency” effects due to significant temperature variation along the pins can lead to significant error in the model [see 40, 41]. For these cases, and where the low thermal conductivity tube materials are used, it is suggested that a conjugate model be developed, possibly along the lines of [19 or 32-34].



330

331

Figure 5 Comparison of Available Experimental Data with Eqn. 26

332

333

334

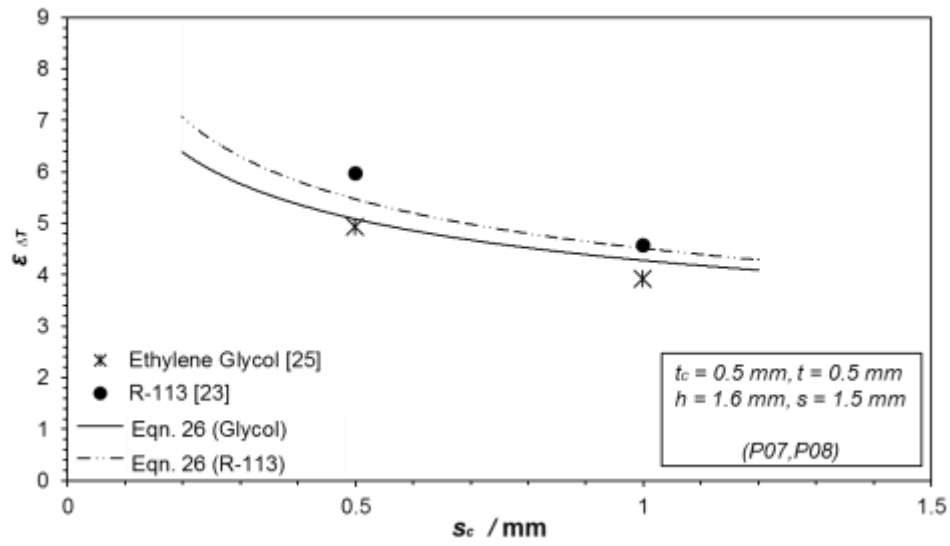
335

336

337

338

339

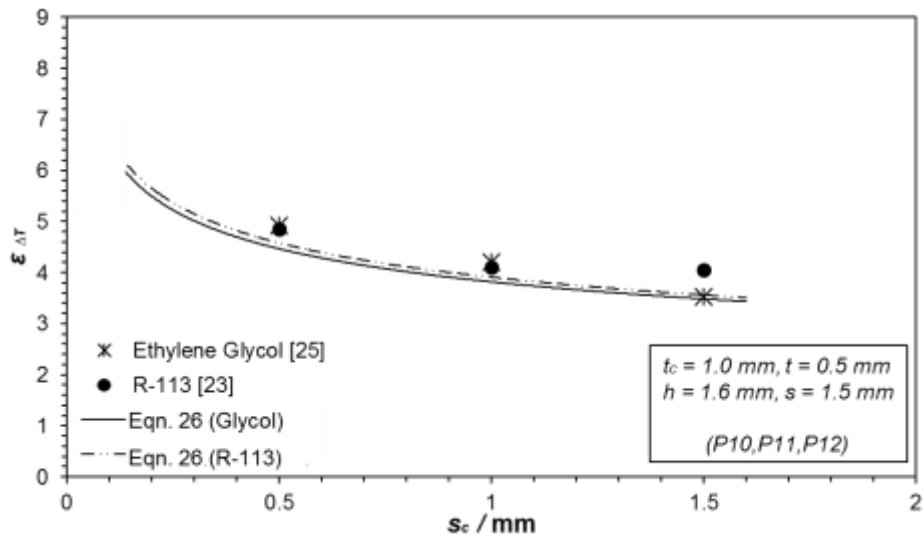


340

341

(a) $t_c = 0.5 \text{ mm}$

342



343

344

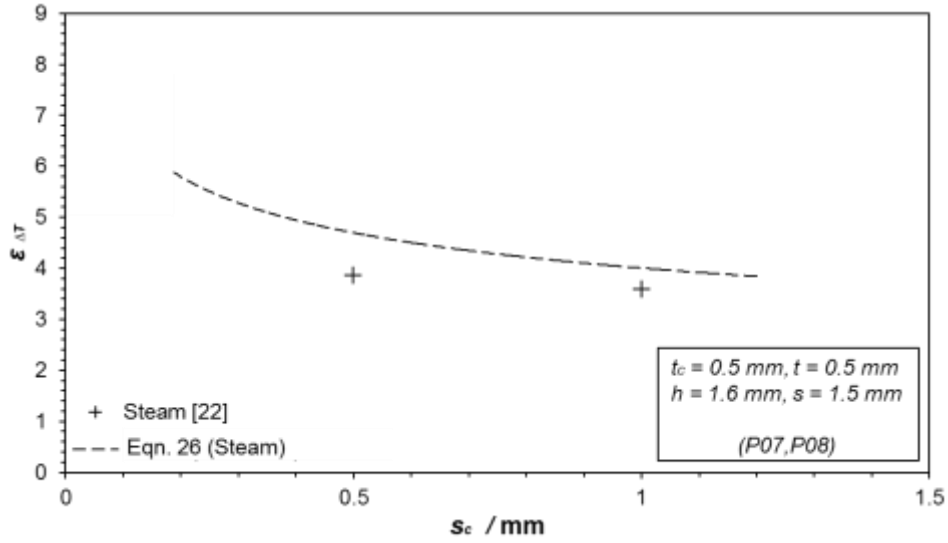
(b) $t_c = 1.0 \text{ mm}$

345

Figure 6 Variation of Heat-Transfer Enhancement Ratio with Circumferential Pin Spacing
(Comparison of Experimental Data of Ali and Briggs [23, 25] with Current Model)

346

347

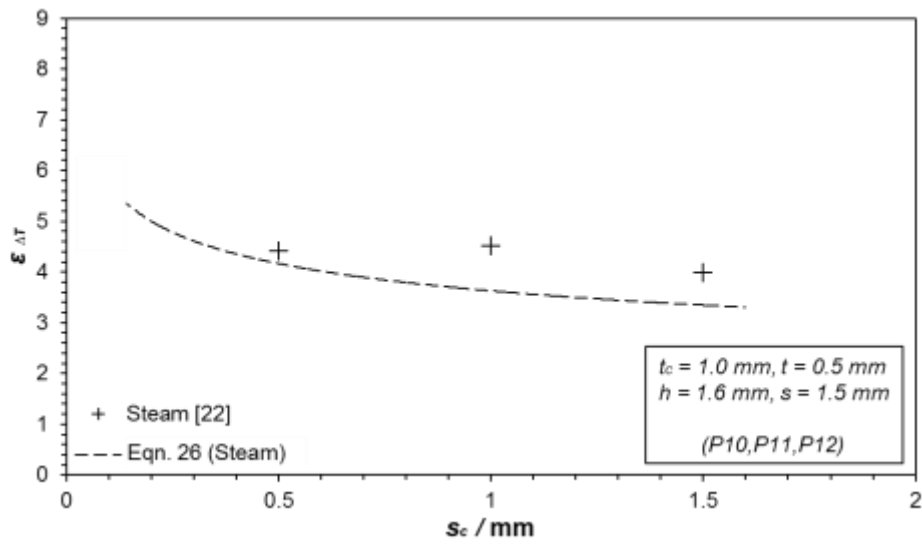


348

349

(a) $t_c = 0.5$ mm

350



351

352

(b) $t_c = 1.0$ mm

353

Figure 7 Variation of Heat-Transfer Enhancement Ratio with Circumferential Pin Spacing

354

(Comparison of Experimental Data of Baiser and Briggs [22] with Current Model)

355

356

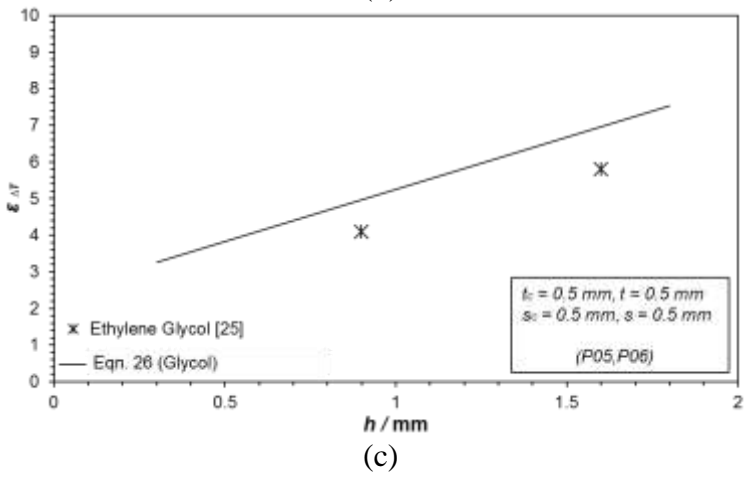
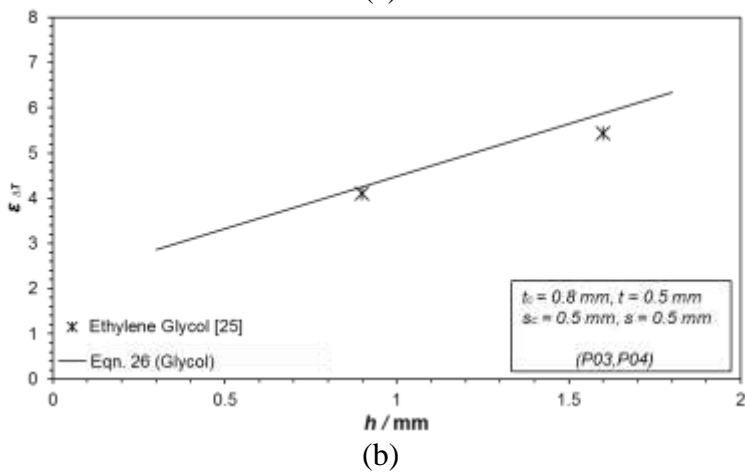
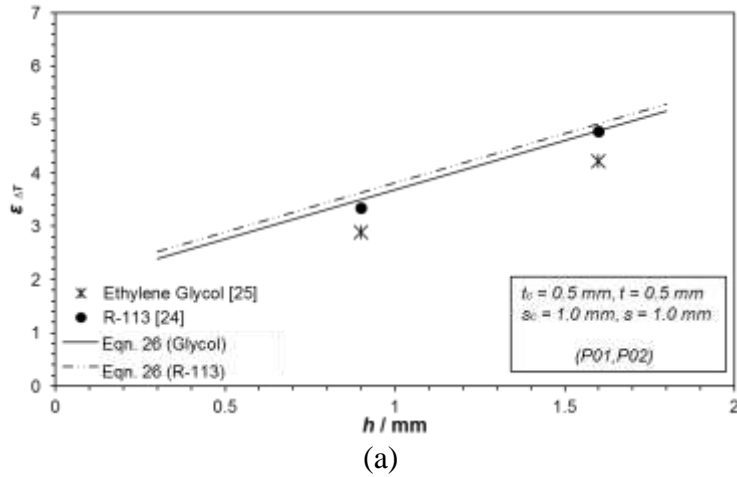
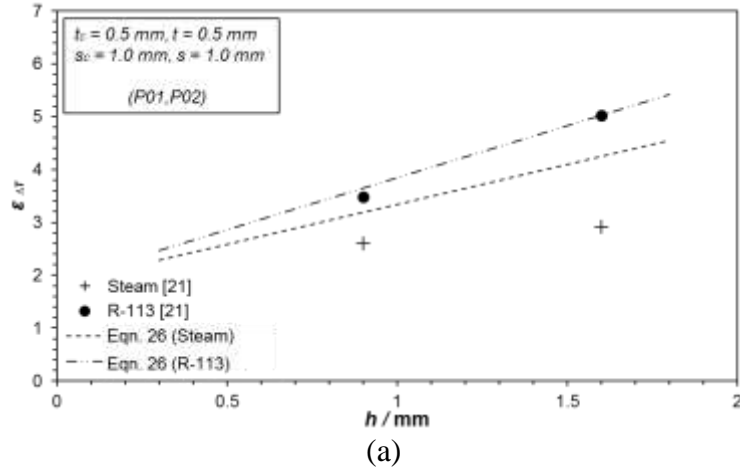
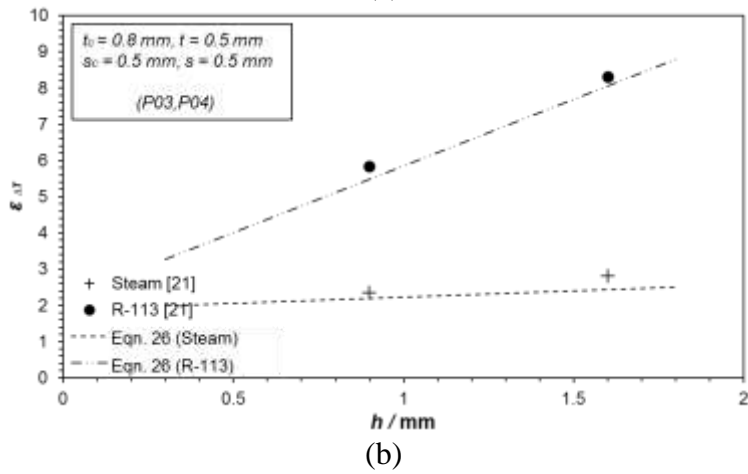


Figure 8 Variation of $\epsilon_{\Delta T}$ with Pin Height
(Comparison of Experimental Data of Ali and Briggs [24, 25] with Current Model)

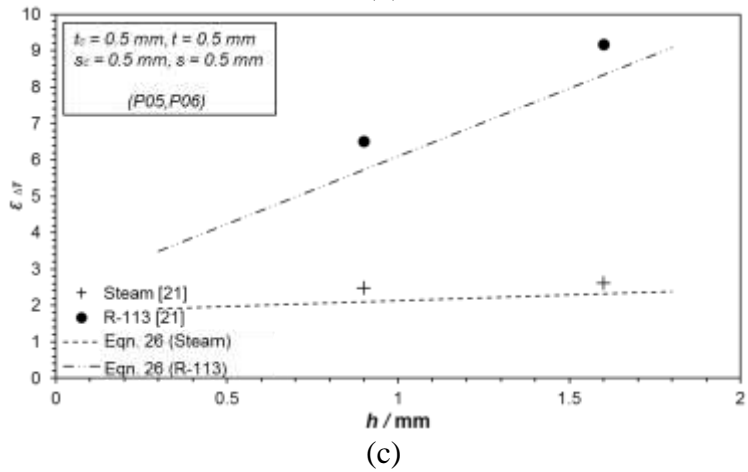
367
368



369
370



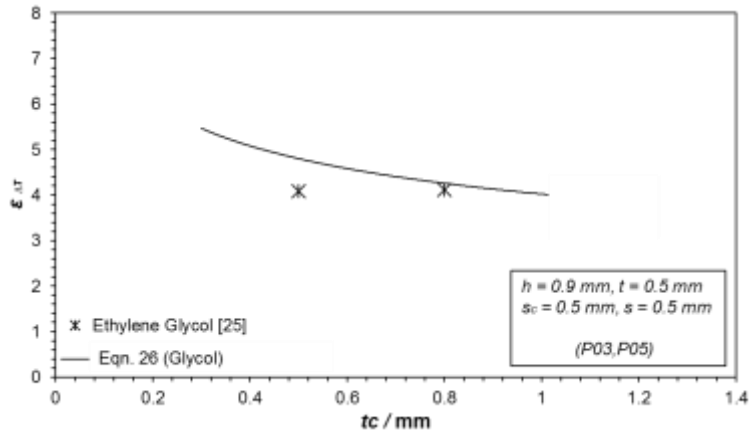
371
372
373



374
375

Figure 9 Variation of $\epsilon_{\Delta T}$ with Pin Height
(Comparison of Experimental Data of Briggs [21] with Current Model)

376

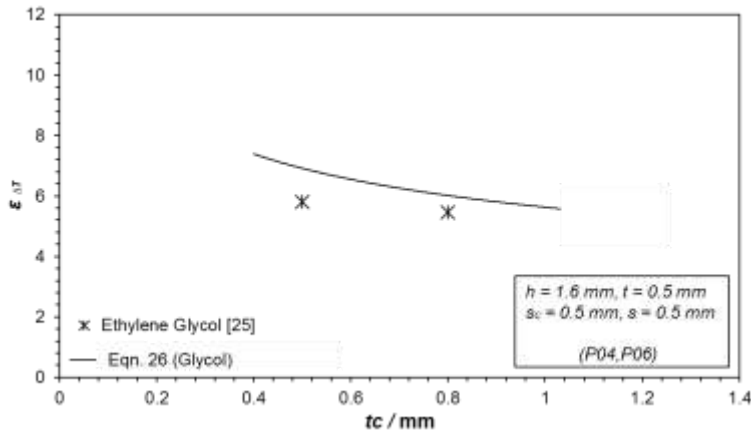


377

378

(a) $h = 0.9$ mm

379



380

381

(b) $h = 1.6$ mm

382

Figure 10 Variation of Heat-Transfer Enhancement Ratio with Circumferential Pin Thickness
(Comparison of Experimental Data of Ali and Briggs [25] with Current Model)

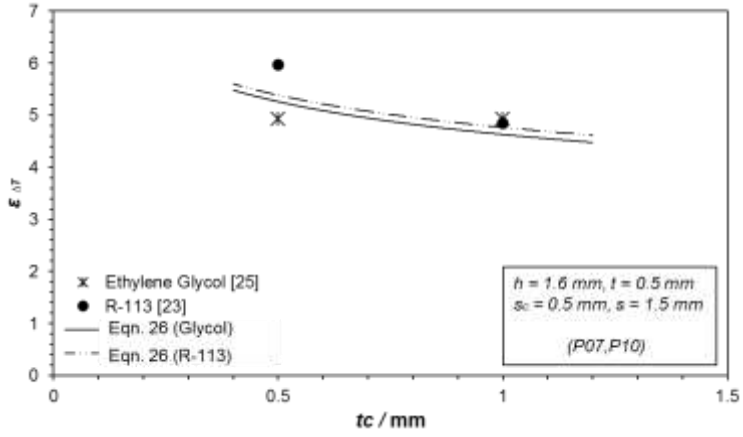
384

385

386

387

388

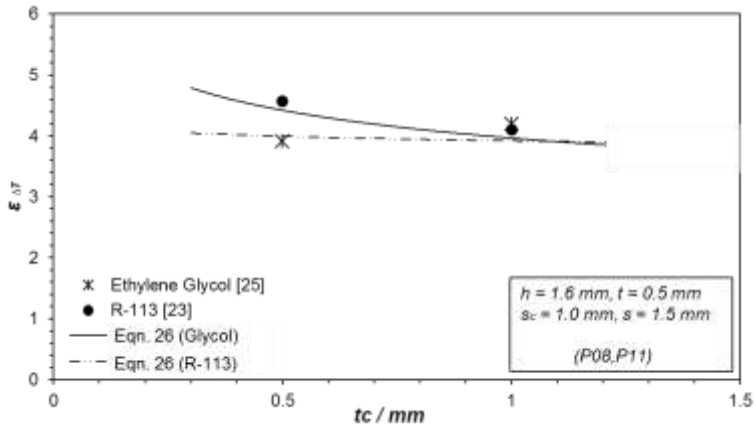


389

390

(c) $s_c = 0.5 \text{ mm}$

391



392

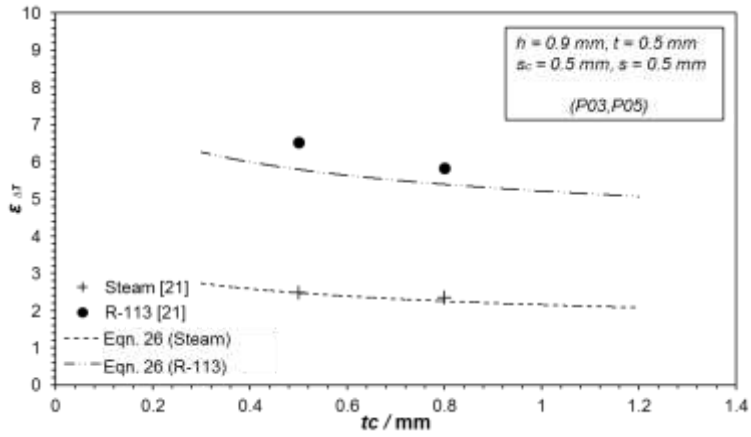
393

(d) $s_c = 1.0 \text{ mm}$

394

Figure 10 (Continued)

395

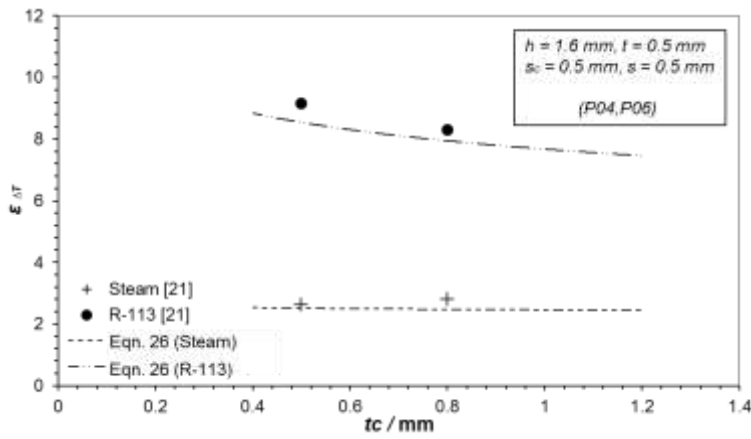


396

397

(a) $h = 0.9$ mm

398



399

400

(b) $h = 1.6$ mm

401

Figure 11 Variation of Heat-Transfer Enhancement Ratio with Circumferential Pin Thickness
(Comparison of Experimental Data of Briggs [21] with Current Model)

402

403

404 **Nomenclature**

405	A	area
406	A_D	constant in Eqn. (4)
407	$A_{flank\ 1}$	area of pin flank 1
408	$A_{flank\ 2}$	area of pin flank 2
409	A_L	constant in Eqn. (3)
410	$A_{root\ 1}$	area of root 1
411	$A_{root\ 2}$	area of root 2
412	A_{tip}	area of pin tip
413	B	constant in Eqn. (3)
414	B_{flank}	empirical constant for pin flank
415	$B_{flank\ 1}$	empirical constant for pin flank 1
416	$B_{flank\ 2}$	empirical constant for pin flank 2
417	B_{root}	empirical constant for root
418	$B_{root\ 1}$	empirical constant for root 1
419	$B_{root\ 2}$	empirical constant for root 2
420	B_{tip}	empirical constant for pin tip
421	C	constant in Eqn. (2)
422	d	outside diameter of plain tube or fin or pin root diameter of finned or pinned tube
423	d_o	fin or pin tip diameter of fin or pin tube
424	g	specific force of gravity
425	j	number of pins in unflooded region
426	h	fin or pin height
427	h_{fg}	specific enthalpy of vaporization
428	h_v	mean vertical fin or pin height
429	k	thermal conductivity of condensate
430	L	length of flat plate
431	n	total number of pins per circumference
432	P	perimeter
433	$P_{flank\ 1}$	perimeter of pin flank 1

434	$P_{flank\ 2}$	perimeter of pin flank 2
435	$P_{root\ 1}$	perimeter of root 1
436	$P_{root\ 2}$	perimeter of root 2
437	P_{tip}	perimeter of pin tip
438	$Q_{flank\ 1}$	heat-transfer rate through all pin flanks 1
439	$Q_{flank\ 2}$	heat-transfer rate through all pin flanks 2
440	$Q_{root\ 1}$	heat-transfer rate through root 1
441	$Q_{root\ 2}$	heat-transfer rate through root 1
442	Q_{tip}	heat-transfer rate through all pin tips
443	q_d	heat flux on outside of a horizontal tube defined by Eqn. (4)
444	q_{flank}	heat flux to fin flank in unflooded part of tube
445	$q_{flank\ 1,i}$	heat flux to flank 1 for pin i defined by Eqn. (10)
446	$q_{flank\ 2,i}$	heat flux to flank 2 for pin i defined by Eqn. (14)
447	q_L	heat flux on a plate defined by Eqn. (3)
448	$q_{root\ 1}$	heat flux through root 1 defined by Eqn. (19)
449	$q_{root\ 2,i}$	heat flux to pin root 2 for a pin i defined by Eqn. (22)
450	q_{tip}	heat flux to fin tip
451	$q_{tip,i}$	heat flux to pin tip i defined by Eqn. (6)
452	$q_{tip,flood}$	heat flux to fin tip in flooded part of tube
453	R_o	pin tip radius
454	s	fin spacing at fin root or longitudinal pin spacing at pin root
455	s_c	circumferential pin spacing
456	t	fin tip thickness or longitudinal pin tip thickness
457	t_c	circumferential pin thickness
458	x_D	linear dimension of tube diameter
459	x_L	linear dimension of plate length
460	x_σ	characteristic length for surface tension driven flow in model

461

462 **Greek Letters**

463	β	angle defined by Eqn. (17)
464	ΔT	temperature difference across the condensate film
465	$\varepsilon_{\Delta T}$	vapour-side, heat-transfer enhancement ratio, heat flux for finned or pinned tube
466		based on fin or pin root diameter divided by heat flux for smooth tube with
467		same fin/pin root diameter, at same vapour-side, temperature difference
468	μ	dynamic viscosity of condensate
469	$\xi(\emptyset)$	function given by Eqn. (5)
470	ρ	density of condensate
471	ρ_v	density of vapour
472	$\tilde{\rho}$	$\rho - \rho_v$
473	σ	surface tension
474	θ	half angle at fin tip
475	\emptyset	angle measured from the top of a fin or pin tube
476	\emptyset_f	condensate flooding or retention angle measured from the top of a fin or pin tube

477 **Subscripts**

478	calc	calculated
479	obs	experimental
480	rel	pertaining to relative residuals
481	Std	pertaining to standard deviation

482

483 **References**

- 484 1. Honda, H., Nozu S. and Mitsumori, K., (1983), Augmentation of Condensation on Finned
485 Tubes by Attaching a Porous Drainage Plate, Proc. ASME-JSME Thermal Engineering Joint
486 Conf., Vol. 3, 289-295.
- 487 2. Yau, K. K., Cooper, J. R., and Rose, J. W., (1985), Effect of Fin Spacing on the Performance
488 of Horizontal Integral-Fin Condenser Tubes, Trans. ASME J. Heat Transfer, Vol. 107, 377-
489 383.

- 490 3. Yau, K. K., Cooper, J. R., and Rose, J. W., (1986), Horizontal Plain and Low-Finned
491 Condenser Tubes- Effect of Fin Spacing and Drainage Strips on Heat Transfer and
492 Condensate Retention, Trans. ASME J. Heat Transfer, Vol. 108, 946-950.
- 493 4. Masuda, H. and Rose, J.W., (1985), An Experimental Study of Condensation of R-113 on
494 Low Integral-Fin Tubes, Proc. Int. Symposium on Heat Transfer., 2, Paper No. 32.
- 495 5. Masuda, H. and Rose, J.W., (1988), Condensation of Ethylene Glycol on Horizontal Finned
496 Tubes, Trans. ASME J. Heat Transfer, Vol. 110, 1019-1022.
- 497 6. Wanniarachchi, A. S., Marto, P. J. and Rose, J. W., (1986), Film Condensation of Steam on
498 Horizontal Finned Tubes: Effect of Fin Spacing, Trans. ASME J. Heat Transfer, Vol. 108,
499 960-966.
- 500 7. Marto, P. J., Mitrou, E., Wanniarachchi, A. S., and Rose, J. W., (1986), Film Condensation
501 of Steam on Horizontal Finned Tubes: Effect of Fin Shape, Proc. 8th International Heat
502 Transfer Conference, Vol. 4, 1695-1700.
- 503 8. Marto, P. J., Zebrowski, D., Wanniarachchi, A. S. and Rose, J. W., (1990), An Experimental
504 Study of R-113 Film Condensation on Horizontal Integral Fin Tubes, Trans. ASME J. Heat
505 Transfer, Vol. 112, 759-767.
- 506 9. Briggs, A. Wen, X. L. and Rose, J. W., (1992), Accurate Heat Transfer Measurements for
507 Condensation on Horizontal, Integral-Fin Tubes, Trans. ASME J. Heat Transfer, Vol. 114,
508 719-726.
- 509 10. Briggs, A., Huang, X. S. and Rose, J. W., (1995), An Experimental Investigation of
510 Condensation on Integral Fin Tubes: Effect of Fin Thickness, Height and Thermal
511 Conductivity, Proc. ASME Nat. Heat Transfer Conference, HTD, Vol. 308, 21-29.
- 512 11. Park, K. J. and Jung, D., (2008), Optimum Fin Density of Low Fin Tubes for the Condensers
513 of Building Chillers with HCFC123, J. of Energy Conservation and Management, Vol. 49,
514 2090-2094.
- 515 12. Katz, D. L., Hope, R. E., and Datsko, S. C., (1946), Liquid Retention on Finned Tubes, Dept.
516 of Eng. Res., Univ. of Michigan, project M592.
- 517 13. Rudy, T. M., and Webb, R. L., (1985), An Analytical Model to Predict Condensate Retention
518 on Horizontal Integral Fin Tubes, Trans. ASME J. Heat Transfer, Vol. 107, 361-368.
- 519 14. Briggs, A., (2005) Liquid Retention on Three-Dimensional Pin-Fin Tubes, 2nd Int. Exergy,
520 Energy and Environment Symp., Kos, Paper No. IEEES2-171.

- 521 15. Fitzgerald, C. L., Briggs, A., Rose, J. W., and Wang, H. S., (2012), Effect of Vapour
522 Velocity on Condensate Retention between Fins during Condensation on Low-Finned Tubes,
523 International J.of Heat and Mass Transfer, Vol. 55, 1412–1418.
- 524 16. Owen, R. G., Sardesai, R. G., Smith, R. A. and Lee, W. C., (1983), Gravity Controlled
525 Condensation on Low Integral Fin Tubes, in Condenser: Theory and Practice, I. Chem. E.
526 Symposium, Serial No. 75, 415–428.
- 527 17. Honda, H. and Nozu S., (1987), A Prediction Method for Heat Transfer During Film
528 Condensation on Horizontal Low Integral Fin Tubes, Trans. ASME J. Heat Transfer, Vol.
529 109, 218–225.
- 530 18. Rose, J. W., (1994), An Approximate Equation for the Vapour-side Heat Transfer Coefficient
531 for Condensation on Low Finned Tubes, International J. of Heat and Mass Transfer, Vol. 37,
532 865–875.
- 533 19. Briggs, A. and Rose, J. W., (1994), Effect of Fin Efficiency on a Model for Condensation
534 Heat Transfer on a Horizontal Integral Fin Tube, International J.of Heat and Mass Transfer,
535 Vol. 37, 457–463.
- 536 20. Sukhatme, S. P., Jagadish, B. S. and Prabhakaran, P., (1990), Film Condensation of R-11
537 Vapor on Single Horizontal Enhanced Condenser Tubes, Trans. ASME J. of Heat Transfer,
538 Vol. 112, 229–234.
- 539 21. Briggs, A., (2003), Enhanced Condensation of R-113 and Steam on Three-Dimensional Pin-
540 Fin Tubes, Exp. Heat Transfer, Vol. 16, 61–79.
- 541 22. Baiser, M., and Briggs, A., (2009), Condensation of Steam on Pin-Fin Tubes: Effect of
542 Circumferential Pin Thickness and Spacing, J. of Heat Transfer Eng., Vol. 30, 1017–1023.
- 543 23. Ali, H. M. and Briggs, A., (2012), Condensation of R-113 on Pin-Fin Tubes: Effect of
544 Circumferential Pin Thickness and Spacing, J. of Heat Transfer Eng., Vol. 33, 205–212.
- 545 24. Ali, H. M. and Briggs, A., (2013), Condensation Heat Transfer on Pin-Fin Tubes: Effect of
546 Thermal Conductivity and Pin Height, J. of Applied Thermal Engineering, Vol. 60, 465–
547 471.
- 548 25. Ali, H. M. and Briggs, A., (2012), Enhanced Condensation of ethylene glycol on Pin-Fin
549 Tubes: Effect of Pin Geometry, Trans. ASME J. of Heat Transfer, Vol. 134, 011503.

- 550 26. Qin, P., Zhang, Z., Xu, T., Gao, X. and Wang, S., (2013), Experimental Investigation on
551 Condensation Heat Transfer of R134a on Single Horizontal Copper and Stainless Steel
552 Three-Dimensional Finned Tubes, AIP Conf. Proc., 1547, 513.
- 553 27. Ali, H. M. and Briggs, A. (2014), An investigation of Condensate Retention on Pin-Fin
554 Tubes, J. of Applied Thermal Engineering, Vol. 63 (2), 503-510.
- 555 28. Kumar, R., Varma, H. K., Mohanty, B. and Agrawal, K. N., (2002), Prediction of Heat
556 Transfer Coefficient During Condensation of Water and R-134a on Single Horizontal
557 Integral-Fin Tubes, International Journal of Refrigeration, Vol. 25, 111–126.
- 558 29. Cavallini, A., Cesni, G., Del Col, D., Doretti, L., Longo, G. A., Rossetto, L. and Zilio, C.,
559 (2003), Condensation Inside and Outside Smooth and Enhanced Tubes: A Review of Recent
560 Research, Int. J. Refrigeration, Vol. 26, 373-392.
- 561 30. Namasivayam, S., (2006), Condensation on Single Horizontal Integral-Fin Tubes: Effect of
562 Vapour Velocity and Fin Geometry, PhD Thesis, Univ. of London.
- 563 31. Briggs, A., and Rose, J.W., (1995), Models for Condensation Heat Transfer on Low-Finned
564 Tubes, Proc. 2nd Baltic Heat Transfer Conf., Riga, 215–225.
- 565 32. Kundu, B. and Lee, K-S., (2011), Optimum Configurations of Vertical Fins under
566 Condensation of Saturated Vapor, International Journal of Refrigeration, Vol. 34, 1048–
567 1056.
- 568 33. Kundu, B., (2009), Approximate Analytical Method for Prediction of Performance and
569 Optimum Dimensions of Pin Fins subject to Condensation of Quiescent Vapor, International
570 Journal of Refrigeration, Vol. 32, 1657–1671.
- 571 34. Kundu, B., and Ghosh, G., (2009), An Approximate Analytical Prediction about Thermal
572 Performance and Optimum Design of Pin Fins subject to Condensation of Saturated Steam
573 Flowing under Forced Convection, International Journal of Refrigeration, Vol. 32, 809–825.
- 574 35. Nagarani, N., Mayilsamy, K., Murugesan, A. and Kumar, G. S., (2014), Review of
575 Utilization of Extended Surfaces in Heat Transfer Problems, Renewable and Sustainable
576 Energy Reviews, Vol. 29, 604–613.
- 577 36. Nusselt, W., (1916), Die Oberflächenkondensation des Wasserdampfes, Z. Vereines
578 Deutsch. Ing., Vol. 60, 541-546, 569-575.

- 579 37. Hajmohammadi, M. R., Poozesh, S., Nourazar, S. S. and Manesh, A. H., (2013), Optimal
580 architecture of heat generating pieces in a fin, *Journal of Mechanical Science and*
581 *Technology*, Vol. 27, 1143-1149.
- 582 38. Hajmohammadi, M. R., Poozesh, S. And Nourazar, S. S., (2012), Constructal design of
583 multiple heat sources in a square-shaped fin, *Journal of Process Mechanical Engineering*,
584 Vol. 226, 324-336.
- 585 39. Hajmohammadi, M. R., Rahmani, M., Campo, M. A. and Shariatzadeh, J. O., (2014),
586 Optimal design of unequal heat flux elements for optimized heat transfer inside a rectangular
587 duct, *Energy*, Vol. 68, 609-616.
- 588 40. Hajmohammadi, M. R. and Nourazar S. S., (2014), Conjugate forced convection heat transfer
589 from a heated flat plate of finite thickness and temperature-dependent thermal conductivity,
590 *Heat Transfer Engineering*, Vol. 35, 863–874.
- 591 41. Hajmohammadi, M. R., Shariatzadeh, J. O., Moulod, M. and Campo, M. A., (2014), Effect of
592 a thick plate on the excess temperature of iso-heat flux heat sources cooled by laminar forced
593 convection flow; Conjugate analysis, *Numerical Heat Transfer, Part A* Vol. 66, 205–216.
594
595